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# **LQA32T300C Qspeed**<sup>™</sup> Family

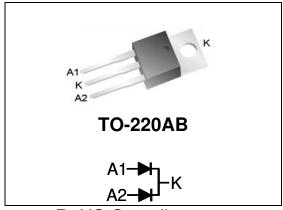


# 300 V, 32 A Q-Series Common-Cathode Diode

## **Product Summary**

I <sub>F(AVG)</sub> per diode	16	Α
$V_{RRM}$	300	<b>V</b>
Q <sub>RR</sub> (Typ at 125 °C)	44	nC
I <sub>RRM</sub> (Typ at 125 °C)	2.65	Α
Softness t <sub>b</sub> /t <sub>a</sub> (Typ at 125 °C)	0.7	

# **Pin Assignment**



RoHS Compliant

Package uses Lead-free plating and Green mold compound. Halogen free per IEC 61249-2-21.

# **General Description**

This device has the lowest  $Q_{RR}$  of any 300V Silicon diode. Its recovery characteristics increase efficiency, reduce EMI and eliminate snubbers.

# **Applications**

- AC/DC and DC/DC output rectification
  - · Output & freewheeling diodes
- · Motor drive circuits
- DC-AC inverters

## **Features**

- Low Q<sub>RR</sub>, Low I<sub>RRM</sub>, Low t<sub>RR</sub>
- High dl<sub>F</sub>/dt capable (1000A/μs)
- Soft recovery

## **Benefits**

- Increases efficiency
  - Eliminates need for snubber circuits
  - Reduces EMI filter component size & count
- · Enables extremely fast switching

# **Absolute Maximum Ratings**

Absolute maximum ratings are the values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Symbol	Parameter	Conditions	Rating	Units
$V_{RRM}$	Peak repetitive reverse voltage		300	V
1	Average forward current	Per Diode, $T_J = 150 ^{\circ}\text{C}$ , $T_C = 104 ^{\circ}\text{C}$	16	Α
I <sub>F(AVG)</sub> Average forward current		Per Device, T <sub>J</sub> = 150 °C, T <sub>C</sub> = 104°C	32	Α
I <sub>FSM</sub>	Non-repetitive peak surge current	60 Hz, ½ cycle	100	Α
I <sub>FSM</sub>	Non-repetitive peak surge current	$1/2$ cycle of t = 28 $\mu$ s Sinusoid, $T_C$ = 25 °C	350	Α
$T_{J}$	Maximum junction temperature		150	°C
T <sub>STG</sub>	Storage temperature		-55 to 150	°C
	Lead soldering temperature	Leads at 1.6mm from case, 10 sec	300	°C
P <sub>D</sub>	Power dissipation	T <sub>C</sub> = 25 °C	65.8	W

## **Thermal Resistance**

Symbol	Resistance from:	Conditions	Rating	Units
$R_{\theta JA}$	Junction to ambient	TO-220AB	62	°C/W
В	Junction to case	Per Diode	1.9	°C/W
$R_{\theta JC}$	Junction to case	Per Device	1.0	°C/W

www.powerint.com January 2011

## LQA32T300C

# **Electrical Specifications** at T<sub>J</sub>= 25 °C (unless otherwise specified)

Symbol	Parameter	Conditions		Min	Тур	Max	Units
DC Chara	acteristics						•
I <sub>R</sub>	Reverse current per diode	$V_R = 300 \text{ V}, T_J = 2$	5 °C	-	-	25	μΑ
		V <sub>R</sub> = 300 V, T <sub>J</sub> = 125 °C		-	0.45	-	mA
V <sub>F</sub>	Forward voltage per diode	I <sub>F</sub> = 16 A, T <sub>J</sub> = 25 °C		-	1.6	1.9	V
		I <sub>F</sub> = 16 A, T <sub>J</sub> = 150 °C		-	1.4	-	V
CJ	Junction capacitance per diode	V <sub>R</sub> = 10 V, 1 MHz		-	50	-	pF
Dynamic	Characteristics						
t <sub>RR</sub>	Reverse recovery time,	dI <sub>F</sub> /dt =200 A/μs	T <sub>J</sub> =25 °C	-	13	-	ns
	per diode	V <sub>R</sub> =200, I <sub>F</sub> =16 A	T <sub>J</sub> =125 °C	-	25	-	ns
Q <sub>RR</sub>	Reverse recovery charge,	dI <sub>F</sub> /dt =200 A/μs	T <sub>J</sub> =25 °C	-	11.5	15	nC
	per diode	V <sub>R</sub> =200, I <sub>F</sub> =16 A	T <sub>J</sub> =125 °C	-	44	-	nC
I <sub>RRM</sub>	Maximum reverse	dI <sub>F</sub> /dt =200 A/μs	T <sub>J</sub> =25 °C	-	1.5	1.85	Α
	recovery current, per diode	V <sub>R</sub> =200, I <sub>F</sub> =16 A	T <sub>J</sub> =125 °C	-	2.65	-	Α
S	a th	dI <sub>F</sub> /dt =200 A/μs	T <sub>J</sub> =25 °C	-	0.7	-	
	Softness per diode= $\frac{t_b}{t_a}$	V <sub>R</sub> =200, I <sub>F</sub> =16 A	T <sub>J</sub> =125 °C	-	0.7	-	

**Note to component engineers**: Q-Series diodes employ Schottky technologies in their design and construction. Therefore, component engineers should plan their test setups to be similar to traditional Schottky test setups. (For further details, see application note AN-300.)

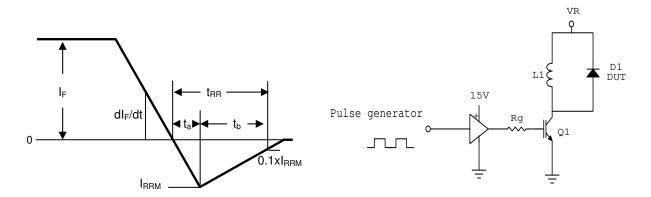


Figure 1. Reverse Recovery Definitions

Figure 2. Reverse Recovery Test Circuit

# Electrical Specifications at T<sub>J</sub>= 25 °C (unless otherwise specified)

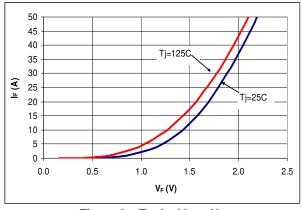


Figure 3. Typical  $I_F$  vs  $V_F$ 

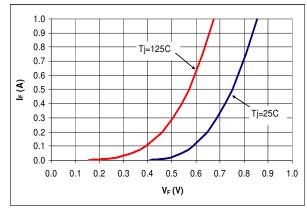


Figure 4. Typical I<sub>F</sub> vs V<sub>F</sub>

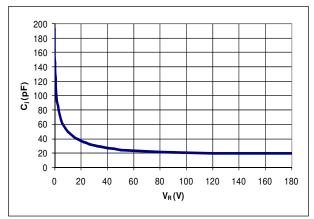


Figure 5. Typical C<sub>i</sub> vs V<sub>R</sub>

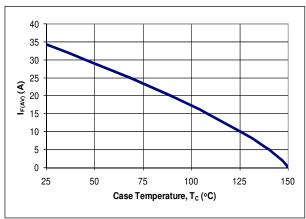


Figure 6. DC Current Derating Curve

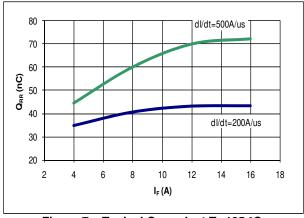


Figure 7. Typical Q<sub>RR</sub> vs I<sub>F</sub> at T<sub>j</sub>=125 °C

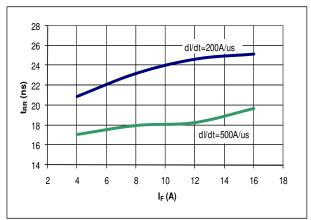
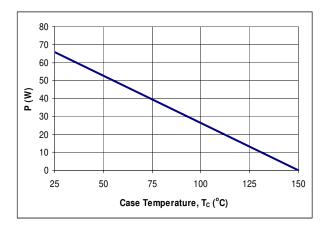


Figure 8. Typical t<sub>RR</sub> vs I<sub>F</sub> at T<sub>i</sub>=125 °C



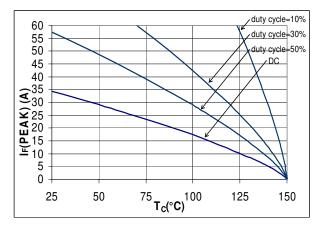


Figure 9. Power Derating Curve

Figure 10. IF(Peak) vs TC, f=70 kHz

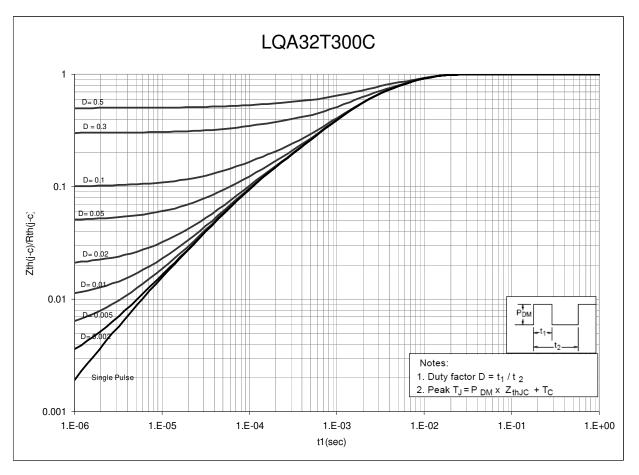
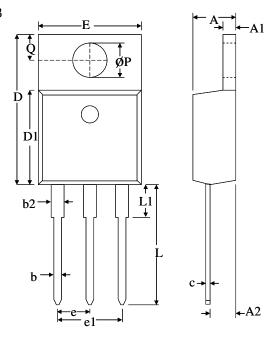


Figure 11. Normalized Maximum Transient Thermal Impedance

# **Dimensional Outline Drawings**

TO-220AB



	Millimeters		
Dim	MIN MAX		
Α	4.32	4.70	
<b>A</b> 1	1.11	1.38	
<b>A</b> 2	2.59	2.79	
b	0.77	1.00	
b2	1.23	1.36	
С	0.34	0.47	
D	14.71	15.75	
D1	9.05	9.25	
E	9.96	10.36	
е	2.44	2.64	
e1	4.98	5.18	
L	12.70	14.22	
L1	_	3.90	
ØΡ	3.71	3.96	
Q	2.54	2.90	

Mechanical Mounting Method	Maximum Torque / Pressure specification	
Screw through hole in package tab	1 Newton Meter (nm) or 8.8 inch-pounds (lb-in)	
Clamp against package body	12.3 kilogram-force per square centimeter (kgf/cm <sup>2</sup> ) or 175 lbf/in <sup>2</sup>	

**Soldering time and temperature:** This product has been designed for use with high-temperature, lead-free solder. The component leads can be subjected to a maximum temperature of 300 °C, for up to 10 seconds. See Application Note AN-303, for more details.

# **Ordering Information**

Part Number	Package	Packing
LQA32T300C	TO-220AB	50 units/tube

The information contained in this document is subject to change without notice.

# LQA32T300C

Revision	Notes	Date
1.0	Released by Qspeed	06/10
1.1	Converted to Power Integrations Document	01/11

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